PATENT ASSIGNMENT

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SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kazuhide ASAI	06/24/2011

RECEIVING PARTY DATA

Name:	Hitachi Kokusai Electric Inc.	
Street Address:	14-1, Sotokanda 4-chome	
Internal Address:	Chiyoda-ku	
City:	Tokyo	
State/Country:	JAPAN	
Postal Code:	1018980	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13175132

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: | HITACHI13-20910139US01 MD

NAME OF SUBMITTER: Melissa D. Doogan

Total Attachments: 2

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PATENT

REEL: 026537 FRAME: 0355

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ASSIGNMENT

ASAI, Kazuhide, residing at 1. Yasuuchi 2-chome. Yatsuo-machi, Toyama-shi, TOYAMA 9392393, Japan, a citizen of Japan (hereafter severally referred to as the undersigned), is the inventor of

STATISTICAL ANALYSIS METHOD AND SUBSTRATE PROCESS SYSTEM

for which the undersigned have executed an application for United States Letters Patent, U.S. Patent Application No. $\frac{13/175,132}{}$, filed $\frac{\text{July 1}}{}$, 2011

The undersigned hereby authorize assignee or assignee's representative to insert the Application Number and the filing date of this application if they are unknown at the time of execution of this assignment.

HITACHI KOKUSAI ELECTRIC INC., a corporation, having a principal place of business at 14-1. Sotokanda 4-chome. Chiyoda-ku, TOKYO 1018980, Japan (hereafter referred to as the assignee), is desirous of acquiring the entire right, title and interest in said invention, all applications for and all letters patent issued on said invention.

For good and valuable consideration, the receipt and sufficiency of which is acknowledged, the undersigned, intending to be legally bound, do hereby sell, assign and transfer to the assignee and assignee's successors, assigns and legal representatives the entire right, title and interest in said invention and all patent applications thereon, including, but not limited to, the application for United States Letters Patent entitled as above, and all divisions and continuations thereof, and in all letters patent, including all reissues and reexaminations thereof, throughout the world, including the right to claim priority under the Paris Convention or other treaty.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, to supply all information and evidence relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention throughout the world for the benefit of the assignee, and to execute all instruments proper to carry out the intent of this instrument.

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The undersigned warrant that the rights and property herein conveyed are free and clear of any encumbrance.

EXECUTED under seal on this 24th day of 7une, 2011 at Toyama-shi, Japan.

Witness:

Minory Kogano (L.S.)

ASAI, Kazuhide

(Although not mandatory, if possible, please subscribe appropriate notarization and obtain APOSTILLE)